EMI FILTER/TVS ARRAY



DFN-16 PACKAGE

DESCRIPTION

The EM8DSLP-100L is a DFN-16, 8 line low pass filter array with integrated TVS diodes. The EM8DSLP-100L is designed to suppress unwanted EMI/RFI signals and provide ESD protection for high-speed data interfaces such as LCD displays and camera imagers for SMART phones.

With a desired cutoff frequency of 150MHz, the EM8DSLP-100L provides good EMI/RFI attenuation better than 35dB in the 800MHz - 3GHz bandwidth. This blocks RF noises from GSM, DCS or Bluetooth which can affect the baseband chipset and other blocks. Coupled with the integrated TVS diodes, this device is able to meet IEC 61000-4-2 (ESD) and 61000-4-4 (EFT) immunity requirements.

FEATURES

• Compatible with IEC 61000-4-2 (ESD): Air - 15kV, Contact - 8kV

- Compatible with IEC 61000-4-4 (EFT): 40A 5/50ns
- ESD Protection > 25 kilovolts
- EMI Filtering/TVS Low Pass Filters
- >25dB Attenuation from 800MHz to 3GHz
- Protects up to 8 Data Lines
- RoHS Compliant
- REACH Compliant

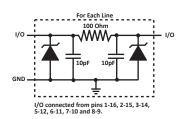
MECHANICAL CHARACTERISTICS

- Molded JEDEC DFN-16SLP (Low Profile) Package
- Approximate Weight: 7 milligrams
- Lead-Free Pure-Tin Plating (Annealed)
- Solder Reflow Temperature:
- Pure-Tin Sn, 100: 260-270°C
- 12mm Tape and Reel Per EIA Standard 481
- Flammability Rating UL 94V-0

APPLICATIONS

- SMART Phones
- LCD Display Panel
- Portable Electronics
- SMART Cards

CIRCUIT DIAGRAM & PIN CONFIGURATION



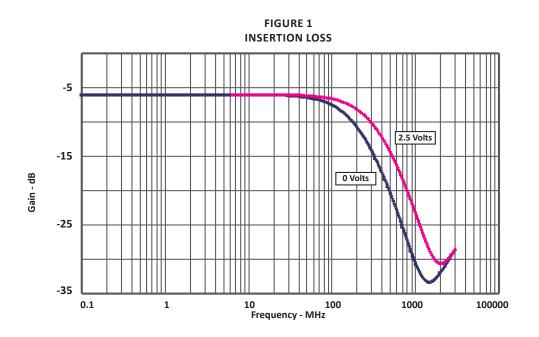
1	2	3	4	5	6	7	8		
GND									
16	15	14	13	12	11	10	9		
BOTTOM VIEW									

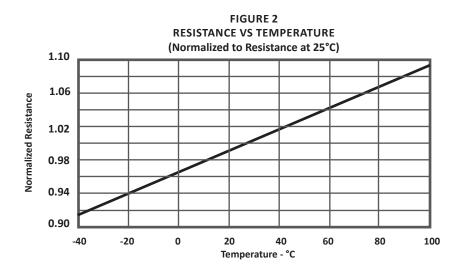
TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified									
PARAMETER	SYMBOL	VALUE	UNITS						
Operating Temperature	T _A	-40 to 85	°C						
Storage Temperature	Т _{stg}	-55 to 150	°C						
DC Power per Resistor	Р	400	mW						
Typical Resistance for 10 seconds	R	100	OHMs						
Soldering Temperature for 10 seconds	Τ _ι	265	°C						

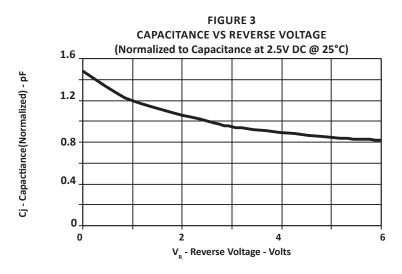
PART NUMBER	DEVICE MARKING			MAXIMUM REVERSE LEAKAGE CURRENT	TYPICAL FORWARD VOLTAGE	MINIMUM	CUT-OFF FREQUENCY (50 OHMS I/O) ZERO BIAS	TYPICAL CAPACITANCE (Note 1)	
		V _{wm} VOLTS	@ 1mA V _(BR) VOLTS	@ 3V Ι _۵ μΑ	@ 10mA V _F VOLTS	@ 800-3000 MHz dB	fC MHz	@2.5V, 1MHz C pF	
EM8DSLP-100L	8SLP	5.0	6.0	0.1	0.8	25	150	20	

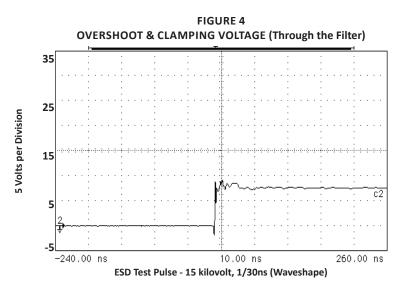
TYPICAL DEVICE CHARACTERISTICS





TYPICAL DEVICE CHARACTERISTICS





DFN-16SLP(LOW PROFILE) PACKAGE INFORMATION

OUTLINE DIMENSIONS								
DIM	MILLIN	IETERS	INCHES					
	MIN	MAX	MIN	MAX				
P1	3.20	3.40	0.126	0.134				
P2	1.25	1.45	0.049	0.057				
Р3	0.45	0.60	0.018	0.024				
L1	0.19	0.28	0.007	0.011				
L2	0.23	0.30	0.009	0.012				
L3	0.13	0.18	0.005	0.007				
р	0.40	BSC	0.016 BSC					
G1	2.70	2.90	0.106	0.114				
G2	0.35	0.45	0.014	0.018				
G4	0.25	0.35	0.010	0.014				
A1	0.00	0.05	0.00	0.002				
К	0.33	0.40	0.013	0.016				

NOTES

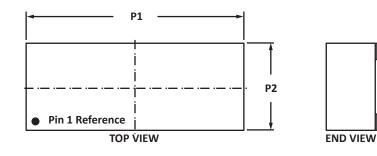
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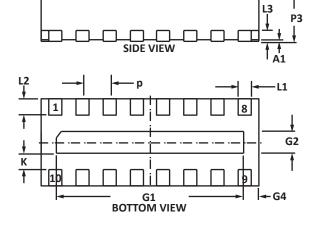
1. Controlling dimension: millimeters.

2. Dimensioning and tolerances per ANSI Y14.M, 1985.

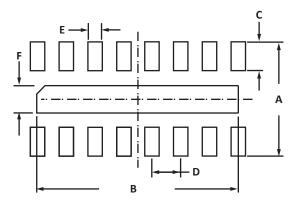
3. Dimension L1 applies to terminal and is measured between 0.25 and 0.30mm from terminal.

4. Coplanarity applies to the exposed pad as well as the terminals.



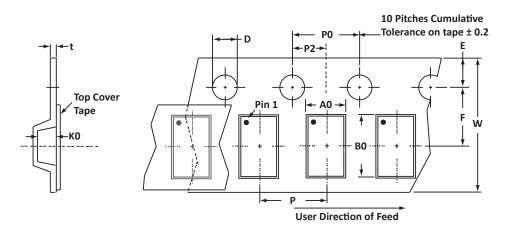


PAD LAYOUT DIMENSIONS								
DIM	MILLIN	IETERS	INCHES					
DIM	MIN	MAX	MIN	MAX				
А	1.56	1.76	0.061	0.069				
В	2.10	2.30	0.083	0.091				
С	0.51	0.61	0.020	0.024				
D	0.40	0.016	016 BSC					
E	0.25	0.35	0.010	0.014				
F	0.20	0.30	0.008	0.012				
NOTES 1. Cont	rolling dimensior	n: millimeters.						



EM8DSLP-100L

TAPE AND REEL



SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	A0	В0	ко	D	E	F	w	PO	P2	Р	tmax
178mm (7")	12mm	1.60 ± 0.10	3.6 ± 0.10	0.60 ± 0.10	1.50 ± 0.10	1.75 ± 0.10	5.50	12.00 ± 0.30	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	0.30 ± 0.05
NOTES 1. Dimensions are in 2. Surface mount pro 3. Suffix - T73 = 7" R 4. Marking on Part - Package outline, pad	oduct is tap eel - 3,000 p marking co	ed and reeled ir vieces per 8mm de (see page 2).	tape.									

ORDERING INFORMATION									
BASE PART NUMBER	LEADFREE SUFFIX	TAPE SUFFIX	TAPE SUFFIX QTY/REEL		TUBE QTY				
EM8DSLP-100L	-LF	-T73	3,000	7"	n/a				

COMPANY INFORMATION

COMPANY PROFILE

ProTek Devices, based in Tempe, Arizona USA, is a manufacturer of Transient Voltage Suppression (TVS) products designed specifically for the protection of electronic systems from the effects of lightning, Electrostatic Discharge (ESD), Nuclear Electromagnetic Pulse (NEMP), inductive switching and EMI/RFI. With over 25 years of engineering and manufacturing experience, ProTek designs TVS devices that provide application specific protection solutions for all electronic equipment/systems.

ProTek Devices Analog Products Division, also manufactures analog interface, control, RF and power management products.

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